

# Crystal Clear Technology

## Product Specification

**T1210X01X00**

(REVISION 3)

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## 2.0 RECORD OF REVISION

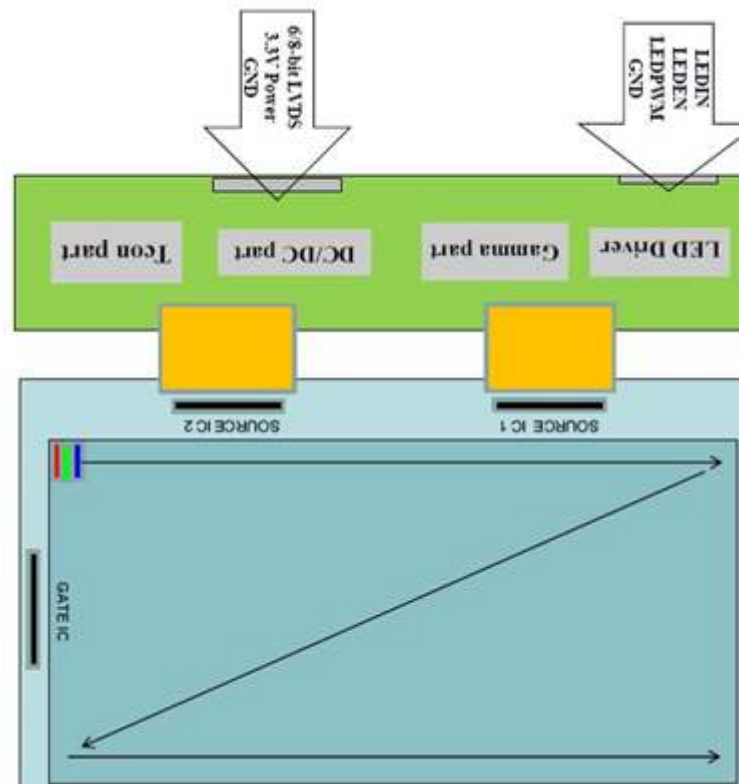
REV	DATE	ITEM	page	Release by
1	15/11/15	Initial Release		Azhar
2	28/01/16	Change model name T1210T01W00 to T1210X01X00		Azhar
3	23/08/17	Change model name T1210X01X00 to T1210T01N00		Azhar



### 3.0 GENERAL DESCRIPTION

#### 3.1 Introduction

T1210T01N00 is a colour active matrix TFT-LCD panel using amorphous silicon TFT's (Thin Film Transistors) as an active switching devices. This model is composed of a TFT-LCD Panel, a driving circuit and a backlight system. It is transmissive type display operating in the normal white. This TFT-LCD has a 12.1 inch diagonally measured active area with SVGA resolutions (800 horizontal by 600 vertical array). Each pixel is divided into Red, Green and Blue dots which arranged in vertical stripe and this pane can display 16.7M (RGB 8-Bits).



#### 3.2 Features

- 0.5t Glass (single)
- Thin and light weight
- High Luminance and contrast ration, low reflection and wide viewing angle
- Module Design
- RoHS Compliant

#### 3.3 Application

- Medical & Industrial Application

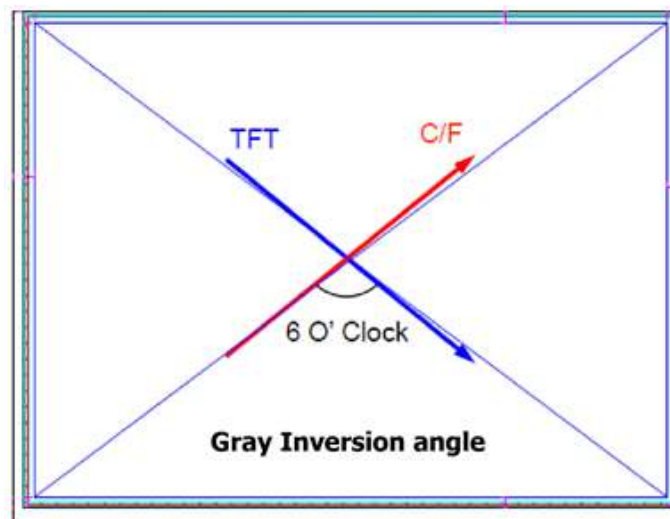


### 3.4 General Specification

Parameter	Specification	Unit	Remark
Active Area	246.0(H) x 184.5 (V)	Mm	
Number of Pixels	800(H)RGB x 600(V)	Pixels	
Pixel Pitch	0.3075(H) x 0.3075(V)	Mm	
Pixel Arrangement	RGB Vertical Stripe		
Display Colors	16.7M	Colors	
Display Mode	55% (typ)		
Dimensional Outline	Normally White, Transmissive mode		
Viewing Direction	279 (H) x 209(V) x 9(D)	Mm	Module
Driver IC	HX8245-C01 / HX8677-G T-con: HX8841		Note1, 2
Weight	TBD	gm	

Note:

1. The biggest CR Direction : 6 O'clock, the worst Grey Inversion Direction : 6 O'clock
2. The TFT and CF Rubbing Direction





## 4.0 ELECTRICAL SEPCIFICATIONS

## 4.1 Absolute Maximum Ratings

The absolute maximum ratings are list on table as follows. When used out of the absolute maximum ratings, the LSI may be permanently damaged. Using LSI within the following electrical characteristics limit is strongly recommended for normal operation. If these electrical characteristics conditions are exceeded during normal operation, the LSY will malfunction and cause poor reliability.

Source IC ---HX8245-C

Parameter	Symbol	Value	Unit
Power Supply voltage	AVDD	14.85	V
Driver supply voltage	VDD	3.96	V
Input voltage	Vr1~Vr18	AVDD+0.3	V
	Others	0.6AVDD	V
Operating temperature range	TOPR	-30~85	°C
Storage Temperature range	TSTG	-55~125	°C

Gate IC --- HX8677-G

Item	Symbol	Value	Unit
Power supply voltage1	VDD	7.0	V
Power supply voltage1	VGH	42.0	V
Power supply voltage3	VGH-42	VGH-42	V
Power supply voltage4	VGH-VGL	42.0	V
Operating temperature range	TOPR	-40~95	°C
Storage Temperature range	TSTG	-55~125	°C

Tcon IC --- HX8841

Item	Symbol	Value	Unit
Supply voltage	VDD	3.6	V
CMOS/TTL input voltage	Vin	3.6	V
CMOS/TTL input voltage	Vout	3.6	V
LVDS receiver input voltage	Vin	3.6	V
Operating temperature range	TOPR	-40~95	°C
Storage Temperature range	TSTG	-55~125	°C



Note:

If the absolute maximum rating of even is one of the above parameters is exceeded even momentarily, the quality of the product may be degraded. Absolute ratings, therefore specify the values exceeding which the product may be physically damaged. Be sure to use the product within the range of the absolute maximum ratings.

#### 4.2 DC Characteristic

Source IC --- HX8245-C

(For the analog circuit)

Parameter	Symbol	Spec.			Unit	Conditions
		Min.	Typ.	Max.		
Supply Voltage	AVDD	6.5	8.4	13.5	V	For the analog circuit power
Input Level of $V_{Y1} \sim V_{Y7}$	$V_{REF}$	0.4AVDD	-	AVDD-0.1	V	Gamma correction voltage
Input Level of $V_{Y8} \sim V_{Y14}$	$V_{REF}$	0.1	-	0.6AVDD	V	Gamma correction voltage
Output Voltage Deviation	$V_{OD}$	-	-	$\pm 20$	mV	-
Voltage Output Offset between Chips	$V_{OC}$	-	-	$\pm 15$	mV	-
Dynamic Range of Output	$V_{DR}$	0.1	-	AVDD-0.1	V	OUT1~OUT1200/1026
Sinking Current of Outputs	$I_{OL}$	-	$-80$	-	$\mu A$	OUT1~OUT1200/1026; AVDD=10V $V_O=0.1V$ v.s 1.0V
Driving Current of Outputs	$I_{OH}$	-	$80$	-	$\mu A$	OUT1~OUT1200/1026; AVDD=10V $V_O=9.9V$ v.s 9.0V
Impedance of Gamma Correction	$R_i$	0.8Rn	1.1Rn	1.4Rn	$\Omega$	Rn: Internal gamma resistor
Analog Stand-by Current	$I_{SC}$	-	3.7	-	mA	No load, AVDD=8.4V and all operating is stopped
Analog Operating Current	$I_{OC}$	-	19	-	mA	$F_{CLK}=40MHz$ $F_{LO}=50KHz$ AVDD=8.4V $V_{Y1}=8V$ $V_{Y14}=0.4V$ in black pattern

Table 6. 3 DC electrical characteristics of analog circuit



## Gate IC --- HX8677-G

Parameter	Symbol	Applicable pin	Condition	Spec.			Unit
				Min.	Typ.	Max.	
Input H voltage	$V_{IH}$	All input pins	-	0.7VDD	-	VDD	V
Input L voltage	$V_{IL}$	All input pins	-	VSS	-	0.3VDD	
Output H voltage	$V_{OH}$	STV1,2	$I_{OH}=40\mu A$	VDD-0.4	-	VDD	
Output L voltage	$V_{OL}$	STV1,2	$I_{OL}=40\mu A$	VSS	-	VSS+0.4	
Output H resistance	$R_{OH}$	OUT1 ~ OUT600	$V_{OUT}=V_{GH}-0.5V$	-	-	1000	$\Omega$
Output L resistance	$R_{OL}$	OUT1 ~ OUT600	$V_{OUT}=V_{GL}+0.5V$	-	-	1000	$\Omega$
Input leakage current	$I_{IN}$	Note <sup>(1)</sup>	-	-1.0	-	+1.0	$\mu A$
Pull high resistance1	$R_{PU}$	/XAO	$V_{IN}=VSS$	40	-	200	k $\Omega$
Pull high resistance2	$R_{PU}$	Note <sup>(2)</sup>	VDD=3.3V, $T_A=25^\circ C$	70	200	400	k $\Omega$
Pull low resistance	$R_{PD}$	Note <sup>(3)</sup>	VDD=3.3V, $T_A=25^\circ C$	70	200	400	k $\Omega$
Power off reset threshold voltage	$V_{POFF}$	-	-	-	1.6	-	V
VGH Power consumption	$I_{VGH}$	VGH	Note <sup>(4)</sup>	-	-	200	$\mu A$
VDD Power consumption	$I_{VDD}$	VDD		-	-	100	

Note: (1) All input except /XAO, MODE1, MODE2, SEG1, SEG2, EVEN

(2) MODE1, MODE2

(3) SEG1, SEG2, EVEN

(4) Power consumption in the following condition:

Output no load,  $V_{GH} = 20V$ ,  $V_{GL} = -8V$ ,  $VDD = 3.0V$ ,

$V_{IH} = VDD$ ,  $V_{IL} = VSS$ ,  $F_{CPV} = 50KHz$ ,  $SEG1 = SEG2 = EVEN = OE1 = OE2 = OE3 = V_{IL}$ ;  $MODE1 = MODE2 = /XAO = V_{IH}$

## 4.3 Backlight Driving Conditions

Parameter	Symbol	Min	Typ	Max	Unit	Remark
LED Forward Voltage	$V_F$	2.9	-	3.4	V	-
LED Forward Current	$I_F$	-	20	-	mA	-
LED Power Consumption	$P_{LED}$	-	2.448	-	W	Note 1
LED Life-Time	N/A		(30,000)		Hrs	IF = 20mA Note 2

Note:

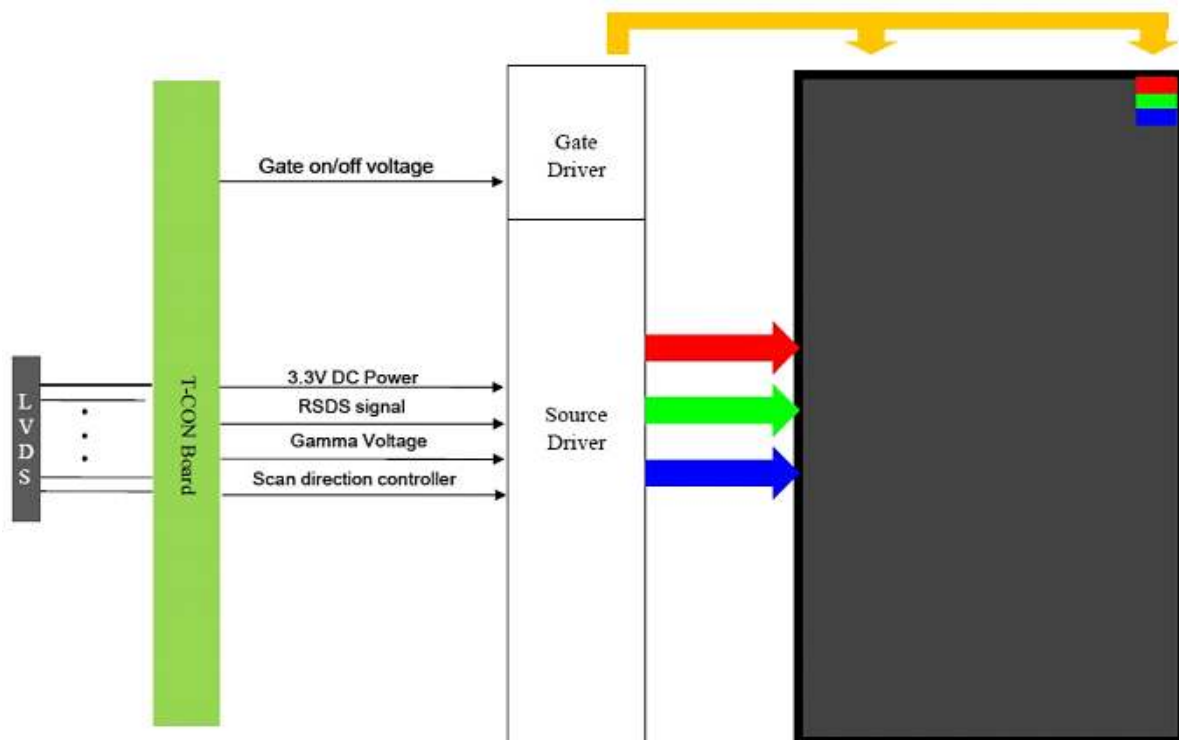
1. Calculator Value for reference  $I_{LED} \times V_{LED} \times LED \text{ Quantity} = P_{LED}$

2. The LED Life-time define as the estimated time to 50% degradation of initial Luminous



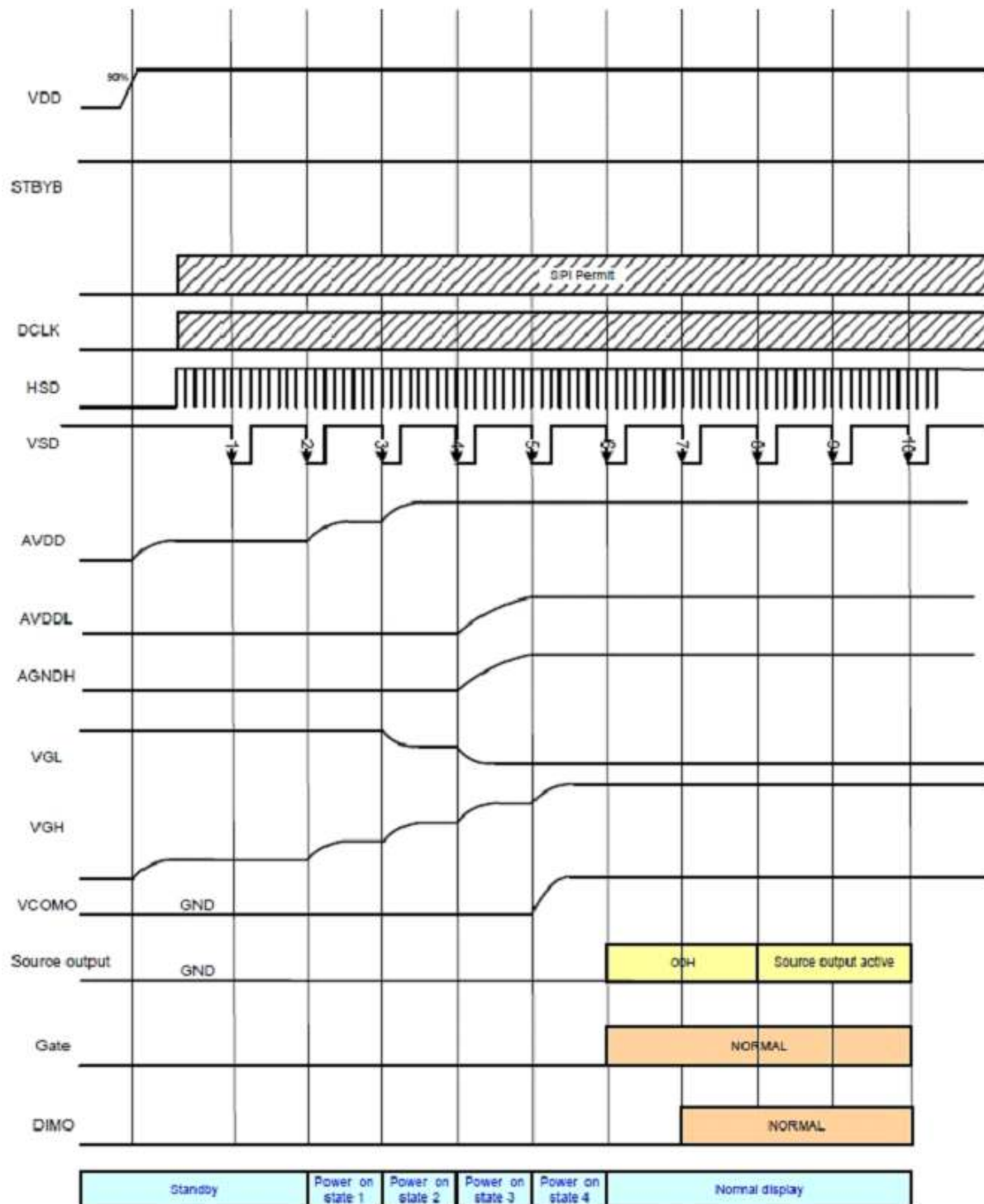


#### 4.4 Block Diagram



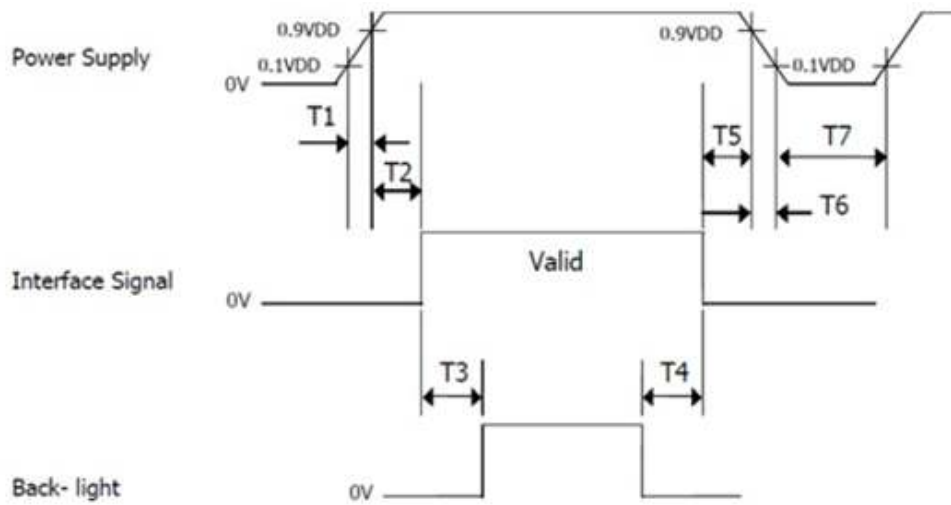


#### 4.5 Input Signals, Basic Display colours and Grey Scale of colours





#### 4.6 Power Sequence



Parameter	Values			Units
	Min	Typ	Max	
T1	0.5	-	10	ms
T2	0	-	50	ms
T3	200	-	-	ms
T4	200	-	-	ms
T5	0.5	-	50	ms
T6	0	-	10	ms
T7	500	-	-	ms



## 5.0 SIGNAL TIMING SPECIFICATION

5.1 The T1040T01W00 is operated by the DE only

Parameter	Symbol	Min	Typ	Max	Unit
DCLK Frequency	fclk	32.6	39.6	62.4	MHz
Horizontal Display Area	thd	800			DCLK
HSD Period	th	900	1056	1300	DCLK
HSD Blanking	thb + thfp	90	200	500	DCLK
Vertical Display Area	tvd	600			TH
VSD Period	tv	610	630	800	TH
VSD Blanking	tvbp + tvfp	10	30	200	TH

DE mode (800 x 600)

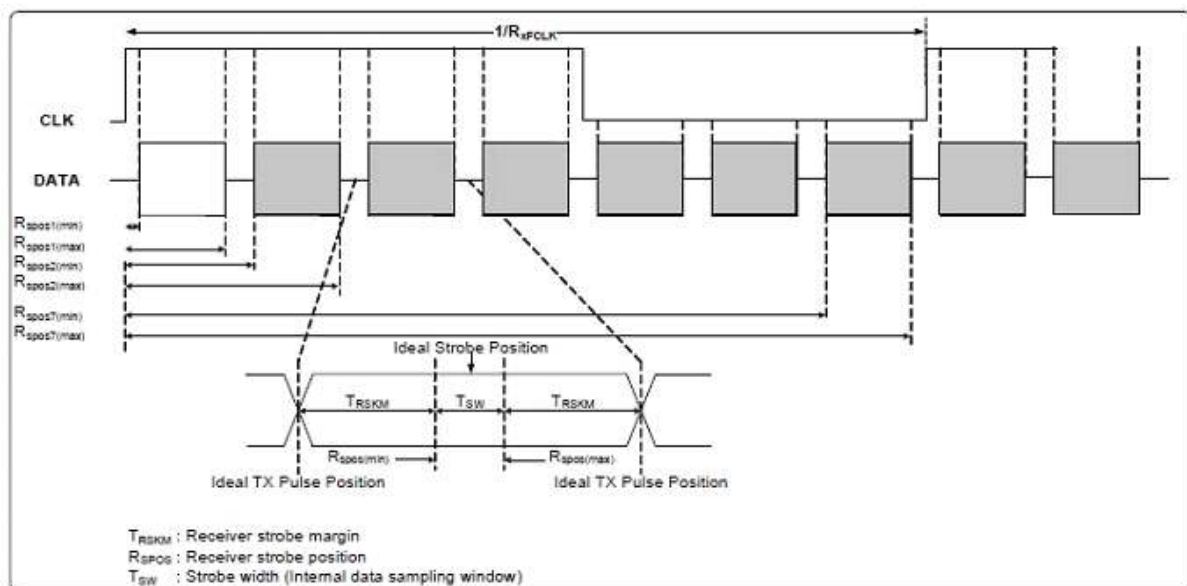
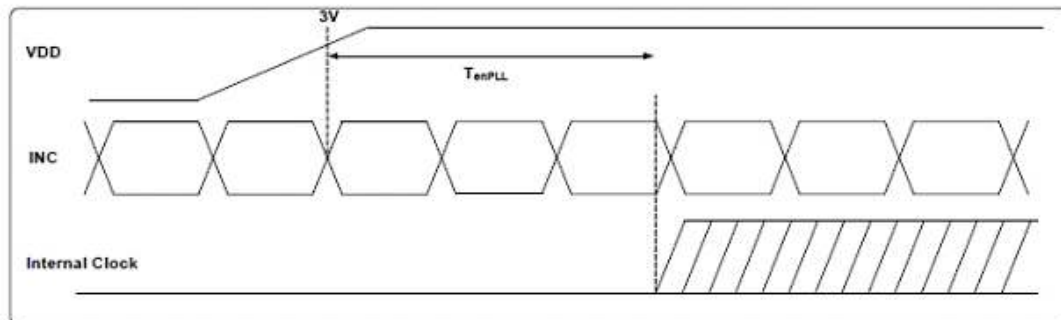
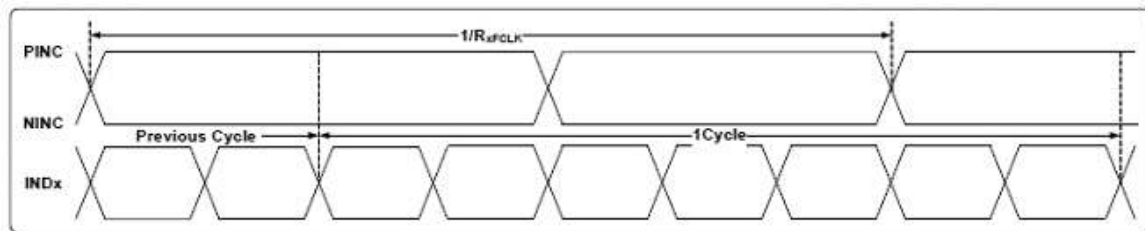
5.2 LVDS Rx Interface Timing Parameter

The Specification of the LVDS Rx Interface timing parameter is shown below.

Parameter	Symbol	Min	Typ	Max	Unit	Condition
Clock frequency	RXFCLK	20	-	85	MHz	-
Input data skew margin	TRSKM	-600	-	+600	pS	VID   =200mV RXVCM =1.2V RXFCLK =65MHz
Clock high time	TLVCH	-	$4/(7 * \text{RXFCLK})$	-	ns	-
Clock low time	TLVCL	-	$3/(7 * \text{RXFCLK})$	-	ns	-
PLL wake-up time	TemPLL	-	-	150	μs	-



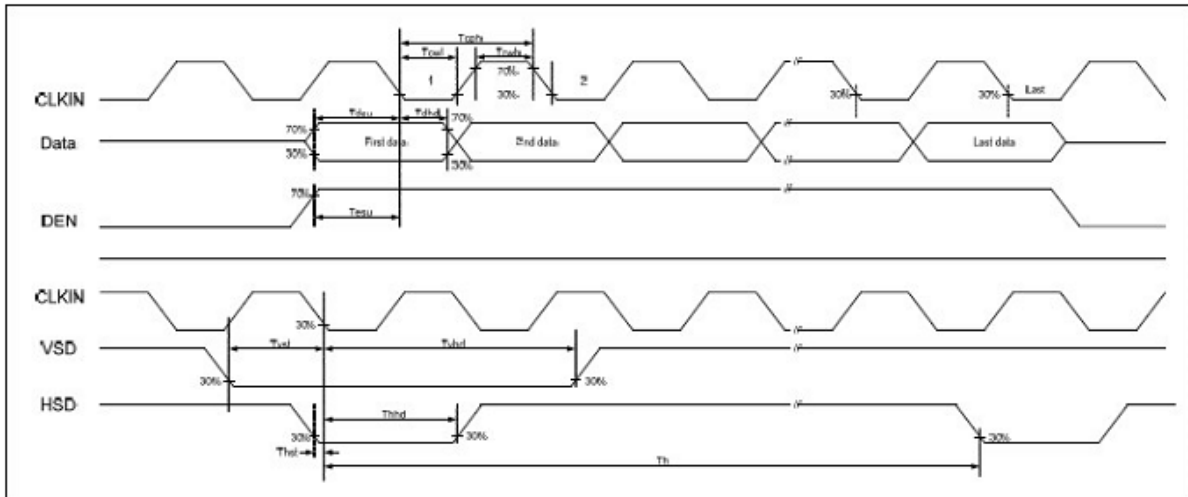
### LVDS mode AD electrical Characteristics



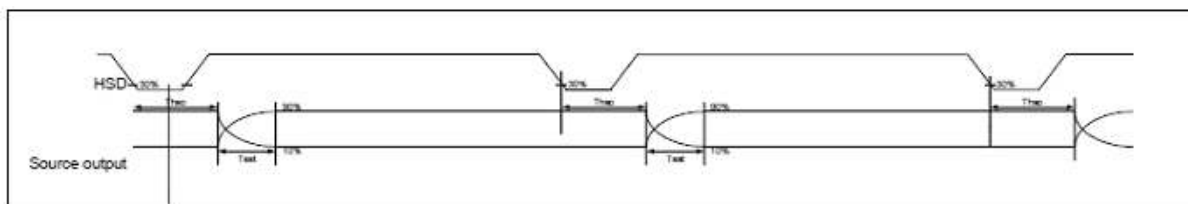


### 5.3 Signal Timing Waveforms of Interface Signal

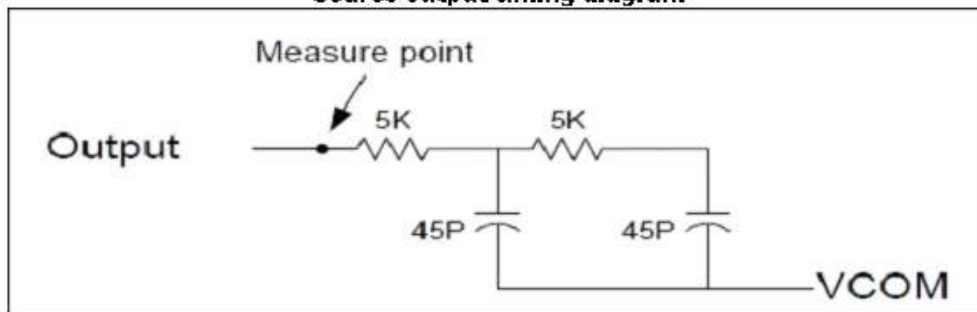
#### a. Input Clock and Data Timing Interface Diagram



#### b. Source Output Timing Diagram



Source output timing diagram



Output load condition



## 6.0 INTERFACE CONNECTION

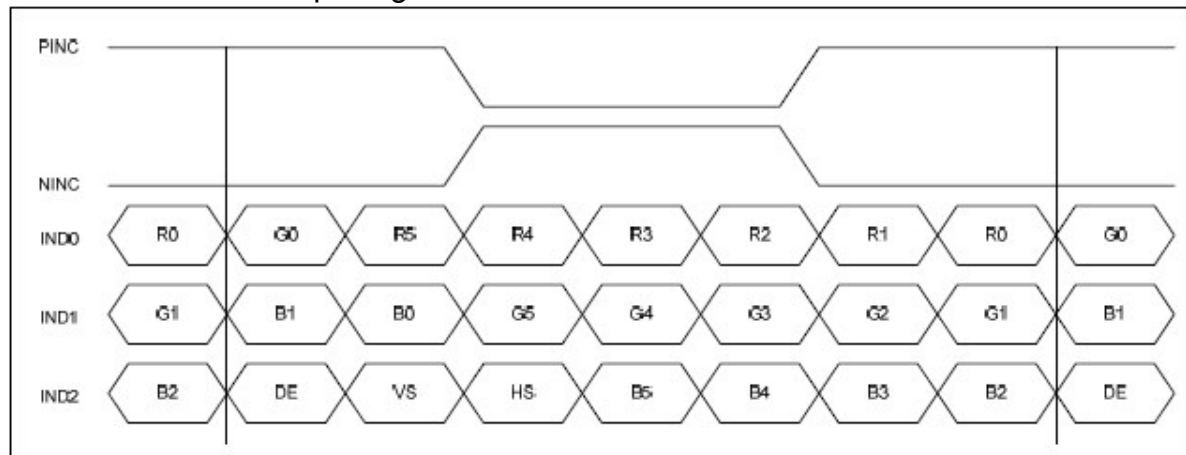
### 6.1 Electrical Interface Connection

The electronics interface connector is STM MSB24013P20 or compatible. The connector interface pin assignments are listed below.

Pin	Symbol	Function
1	VDD	Logic Power 3.3V (Panel logic)
2	VDD	Logic Power 3.3V (Panel logic)
3	GND	Ground
4	GND	Ground
5	IN0-	LVDS receiver negative signal channel 0
6	IN0+	LVDS receiver positive signal channel 0
7	GND	Ground
8	IN1-	LVDS receiver negative signal channel 1
9	IN1+	LVDS receiver positive signal channel 1
10	GND	Ground
11	IN2-	LVDS receiver negative signal channel 2
12	IN2+	LVDS receiver positive signal channel 2
13	GND	Ground
14	CLK-	LVDS receiver negative signal clock
15	CLK+	LVDS receiver positive signal clock
16	GND	Ground
17	IN3-	LVDS receiver negative signal channel 3 (NC for 6bit LVDS input)
18	IN3+	LVDS receiver positive signal channel 3 (NC for 6bit LVDS input)
19	GND	Ground
20	SEL68	6/8bits LVDS data input selection [H: 8bit L/NC: 6bit]

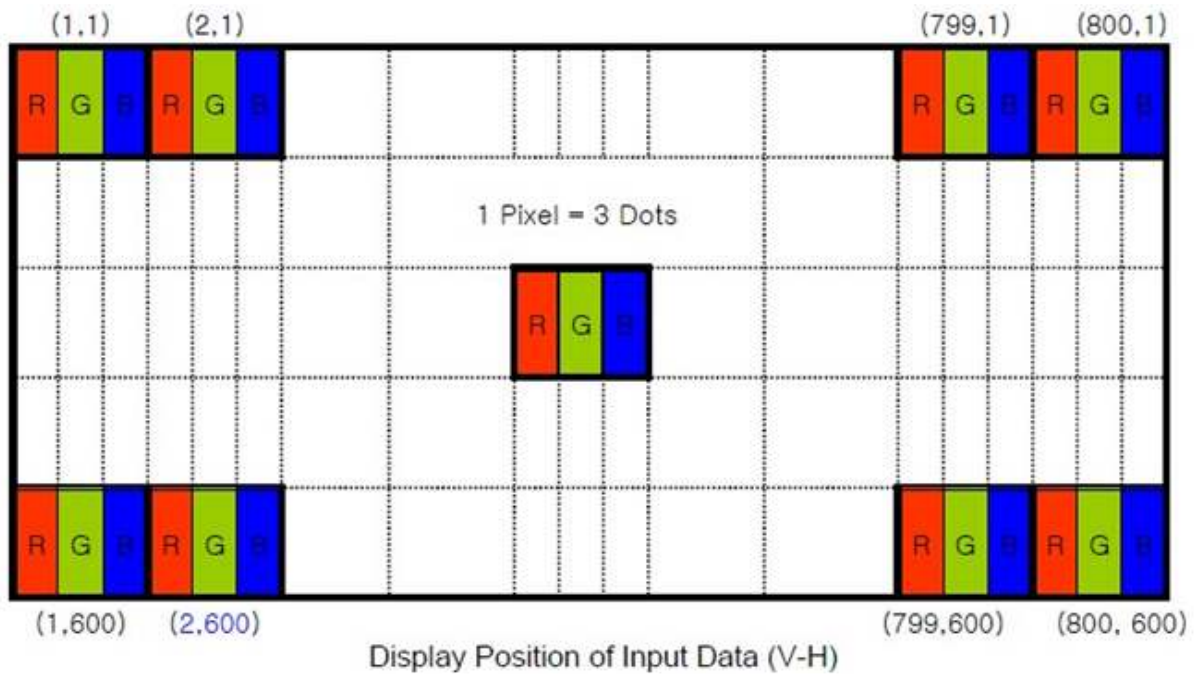
Note1: High Stands for “2.7 — 3.3”, Low stands for “0 -- 0.4”

### 6.2 LVDS input signal





### 6.3 Data Input Format







## 7.0 OPTICAL SPECIFICATIONS

### 7.1 Overview

The test of Optical specifications shall be measured in a dark room (ambient luminance  $\leq 1$  lux and temperature =  $25 \pm 2^\circ\text{C}$ ) with the equipment of Luminance meter system (Topcon SR-UL1R and Westar TRD-100A) and test unit shall be located at an approximate distance 50cm from the LCD surface at a viewing angle of  $\theta$  and  $\phi$  equal to  $0^\circ$ . The centre of the measuring spot on the Display surface shall stay fixed.

The backlight should be operating for 30 minutes prior to measurement. Optimum viewing angle direction is 12 o'clock.

### 7.2 Optical Specifications

Parameter		Symbol	Condition	Min.	Typ.	Max.	Unit	Remark
Threshold Voltage		Vsat		2.0	2.2	2.4	V	Fig.1
		Vth		1.1	1.3	1.5	V	
Viewing Angle	Horizontal	Θ3	CR>10	60	70		°	Note 1
		Θ9		60	70		°	
	Vertical	Θ12		50	60		°	
		Θ6		60	70		°	
Contrast Ratio		CR	Θ= 0°	300	400			Note 2
Luminance		cd/m2	Θ= 0°	350	400		lm	Note 3
Uniformity		%	Θ= 0°	70%	80%			Note 4
NTSC		%	Θ= 0°		50%			
Reproduction Of color	Red	Rx	Θ= 0°		TBD			Note 5 *Module
		Ry			TBD			
	Green	Gx			TBD			
		Gy			TBD			
	Blue	Bx			TBD			
		By			TBD			
White		Wx	Θ= 0°		TBD			
		Wy			TBD			
Response Time		Tr+Tf	Θ= 0°		25		ms	Note 6

**Note:**

1. Viewing angle is the angle at which the contrast ratio is greater than 10. The viewing are determined for the horizontal or 3, 9 o'clock direction and the vertical or 6, 12 o'clock direction with respect to the optical axis which is normal to the LCD surface (see FIG.2).
2. Contrast measurements shall be made at viewing angle of  $\theta = 0^\circ$  and at the centre of the LCD surface. Luminance shall be measured with all pixels in the view field set first to white, then to the dark (black) state. (See FIG. 2) Luminance Contrast Ratio (CR) is defined mathematically.



$$CR = \frac{\text{Luminance when displaying a white raster}}{\text{Luminance when displaying a black raster}}$$

3. Surface luminance is the center point across the LCD surface 50cm from the surface with all pixels displaying white. This measurement shall be taken at the locations shown in FIG. 2.

4. Uniformity measurement shall be taken at the locations shown in FIG. 2&3, for a total of the measurements per display, measure surface luminance of these nine points across the LCD surface 50cm from the surface with all pixels displaying white.

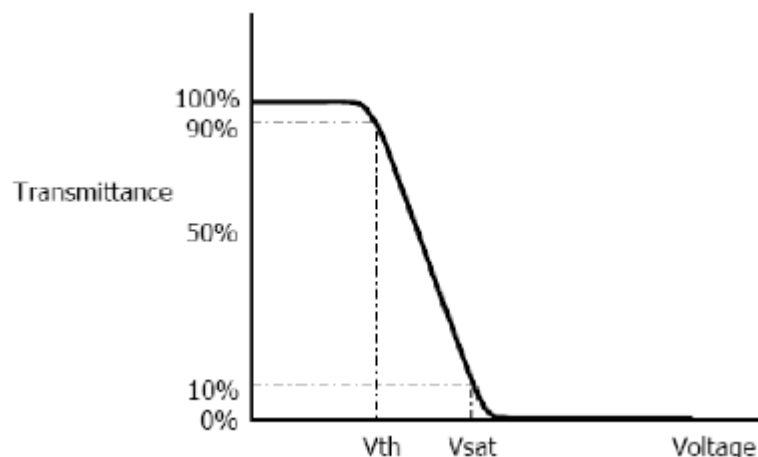
$$\text{Uniformity} = \frac{\text{Min Luminance of 9 points}}{\text{Max Luminance of 9 points}} \times 100\%$$

5. The color chromaticity coordinates specified in Table1 shall be calculated from The spectral data measured with all pixels first in red, green, blue and white. Measurements shall be made at the center of the Module.

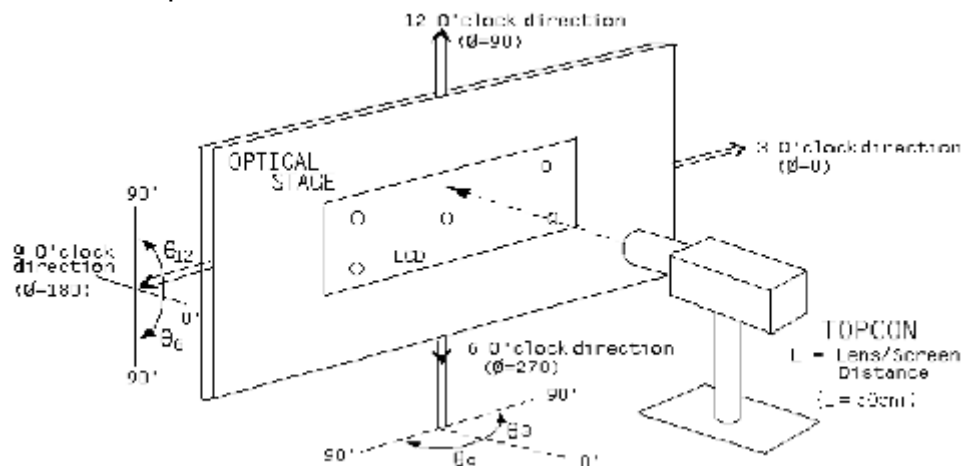
6. The electro-optical response time measurements shall be made as FIG.4 by switching the "data" input signal ON and OFF.

The times needed for the luminance to change from 10% to 90% is Tr and 90% to 10% is Tf.

The definition of Vth & Vsat

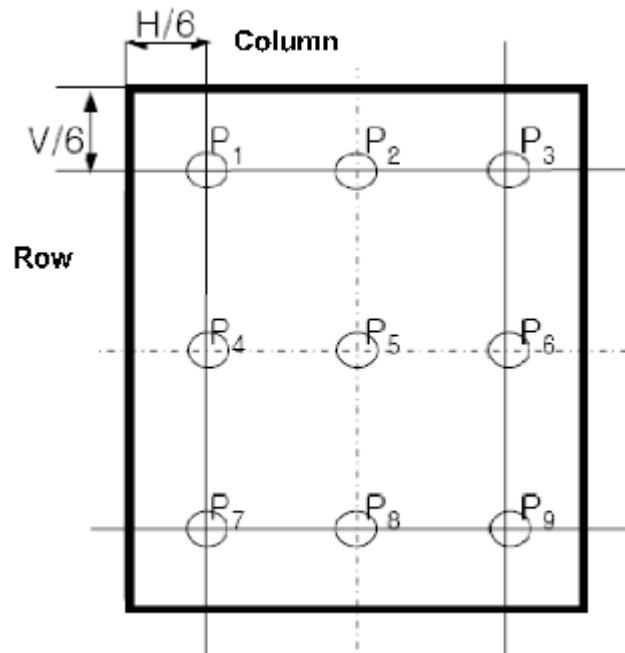


Measurement Set up

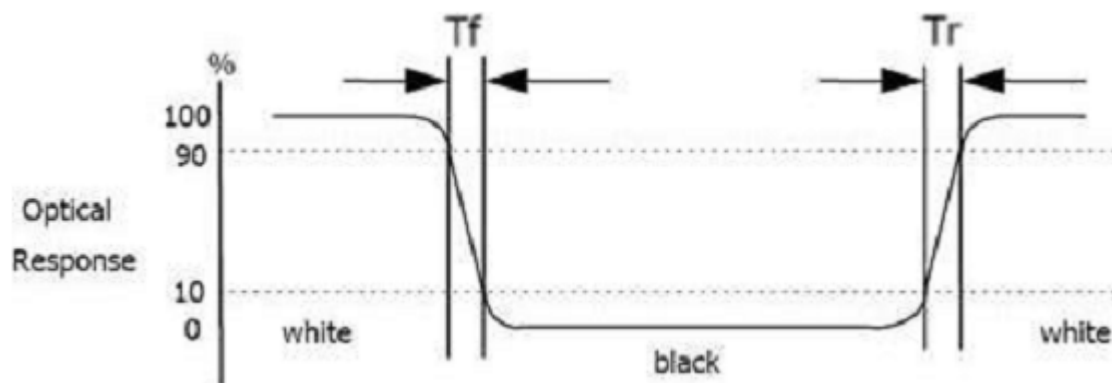




### Uniformity Measurement Locations



### Response Time Testing





## 8.0 MECHAICAL CHARACTERITICS

### 8.1 Dimension Requirements

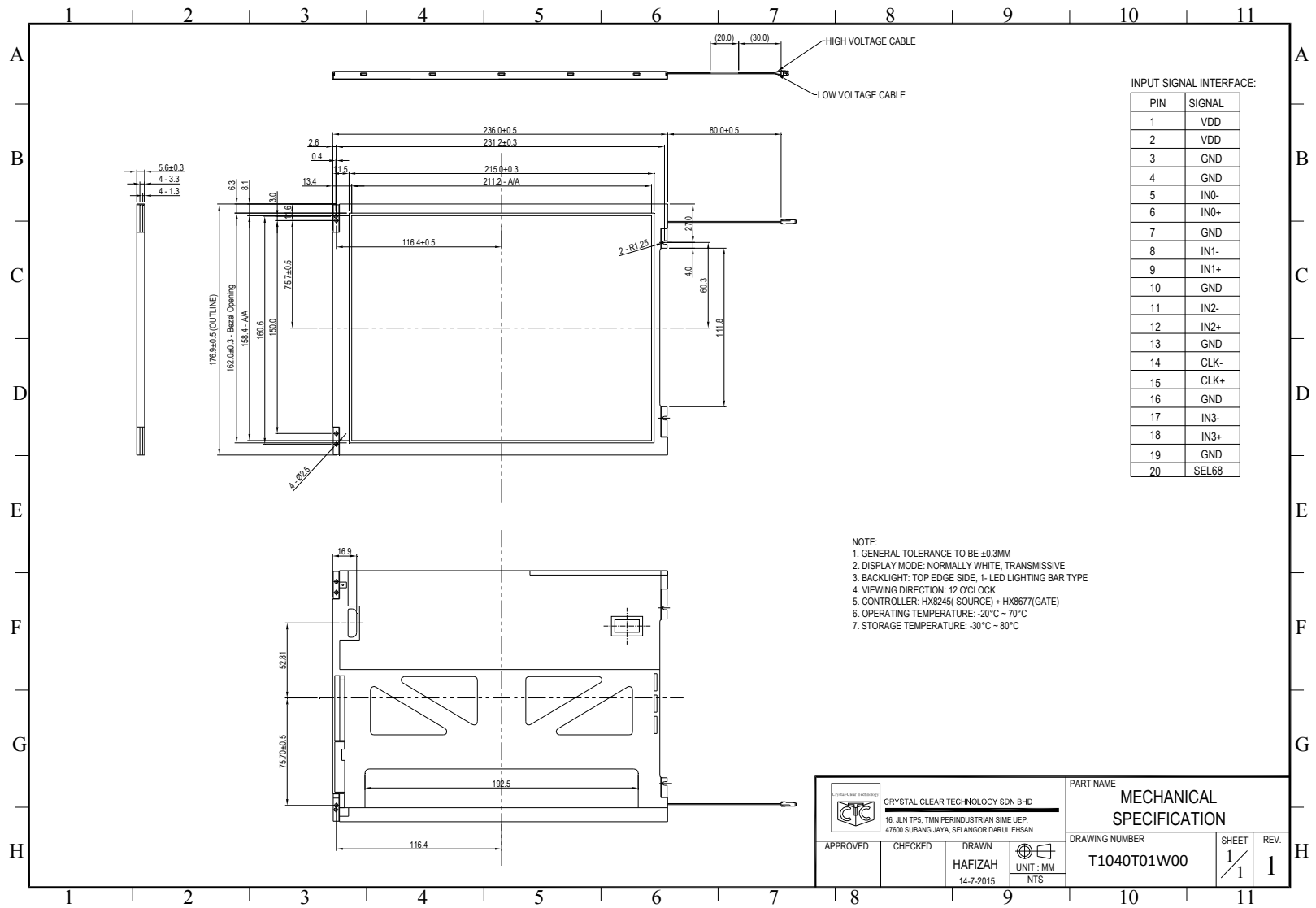
Mechanical outlines for the panel (H: horizontal length, V: vertical length)

Parameter	Specification	Unit	Remark
Panel size	221.6(H) × 171(V)	mm	
CF size	218.4(H) × 165.4(V)	mm	
Active area	211.2(H) × 158.4(V)	mm	
Number of pixels	800(H)RGB × 600(V)	pixels	
	(1 pixel = R + G + B dots)		
Pixel pitch	0.264(H) × 0.264(V)	mm	
Pixel arrangement	RGB Vertical stripe		
Panel ID	10 × 2	mm	
COG pad area	5.6(Source), 3.2(Gate)	mm	
D-IC to FPC distance	0.5(Source)	mm	Note
D-IC width	1.07(Source), 0.67(Gate)	mm	
D-IC to CF edge	2.83(Source), 1.87(Gate)	mm	
FPC to Glass edge	0.3(Source)	mm	
FPC width	0.9(Source)	mm	
Seal Area (U/D/L/R)	3.5/3.5/3.6/3.6	mm	
Dimensional outline	236(H) × 176.9(V) × 5.6(D)	mm	
Display mode	Normally white		

Note:

The size specified in calculated by IC driver HX8245 (Source) + HX8677 (Gate), the size may be changes if customer use other IC.

## LCM Outline Dimension



**9.0 RELIABILITY TEST**

<b>NO.</b>	<b>Test Item</b>	<b>Test Condition</b>	<b>Duration</b>
1	High temperature, high humidity operation test(THO)	60°C, 90%RH	240hrs
2	Low temperature operation test(LTO)	-20 °C	240hrs
3	High temperature operation test(HTO)	70 °C	240hrs
4	High temperature storage test(HTS)	80°C	240hrs
5	Low temperature storage test(LTS)	-30°C	240hrs
6	Thermal shock test (TST)	-30 °C →80 °C (Per 30min )	100hrs
7	Altitude test(ALT)	25°C,40000ft	12hrs
8	On/Off	On 30s / Off 30s	3000times
9	PCT	121 °C,2ATM ,100%RH	12hr
10	ESD	150pF 330Ω ±8KV(Air) / ±6KV(Contact)	20points
11	Vibration	1.5G ,10/500/10,Sine,X/Y/ Z Direction	Total:30min



## **10.0 HANDLING & CAUTIONS**

### **10.1 Mounting Method**

- The panel of the LCD consists of two thin glasses with polarizer which easily get damaged.
- So extreme care should be taken when handling the LCD.
- Excessive stress or pressure on the glass of the LCD should be avoided. Care must be taken to insure that no torsional or compressive forces are applied to the LCD unit when it is mounted.
- If the customer's set presses the main parts of the LCD, the LCD may show the abnormal display. But this phenomenon does not mean the malfunction of the LCD and should be pressed by the way of mutual agreement.
- To determine the optimum mounting angle, refer to the viewing angle range in the specification for each model.
- Mount a LCD module with the specified mounting parts.

### **10.2 Caution of LCD Handling and Cleaning**

- Since the LCD is made of glass, do not apply strong mechanical impact or static load onto it.
- Handling with care since shock, vibration, and careless handling may seriously affect the product.
- If it falls from a high place or receives a strong shock, the glass maybe broken.
- The polarizer on the surface of panel are made from organic substances. Be very careful for chemicals not to touch the polarizer or it leads the polarizer to be deteriorated.
- If the use of a chemical is unavoidable, use soft cloth with solvent recommended below to clean the LCD's surface with wipe lightly.
- -IPA (Isopropyl Alcohol), Ethyl Alcohol, Tri-chloro, tri-florothane.
- Do not wipe the LCD's surface with dry or hard materials that will damage the polarizer and others. Do not use the following solvent—Water, acetone, Aromatics.
- It is recommended that the LCD be handled with soft gloves during assembly, etc. The polarizer on the LCD's surface are vulnerable to scratch and thus to be damaged by shape particles.
- Do not drop water or any chemicals onto the LCD's surface.
- A protective film is supplied on the LCD and should be left in place until the LCD is required for operation.
- The ITO pad area needs special careful caution because it could be easily corroded. Do not contact the ITO pad area with HCFC, Soldering flux, Chlorine, Sulphur, saliva or fingerprint. To prevent from the ITO corrosion, customers are recommended that the ITO area would be covered by UV or silicon
- Please clean the LCD without ultrasonic to avoid line open.



### **10.3 Caution Against Static Charge**

- The LCD modules use C-MOS LSI drivers, so customers are recommended that any unused input terminal would be connected to Vdd or Vss, do not input any signals before power is turn on, and ground you body, work/assembly area, assembly equipment's to protect against static electricity.
- Remove the protective film slowly, keeping the removing direction approximate 30-degree not vertical from panel surface, if possible, under ESD control device like ion blower, and the
- Humidity of working room should be kept over 50%RH to reduce the risk of static charge.
- Avoid the use work clothing made of synthetic fibres. We recommend cotton clothing or other conductivity-treated fibres.
- In handling the LCD, wear non-charged material gloves. And the conducting wrist to the earth and the conducting shoes to the earth are necessary.

### **10.4 Caution For Operation**

- It is indispensable to drive the LCD within the specified voltage limit since the higher voltage than the limit causes the shorter LCD's life. An electro-chemical reaction due to DC causes undesirable deterioration of the LCD so that the use of DC drive should avoid.
- Do not connect or disconnect the LCD to or from the system when power is on.
- Never use the LCD under abnormal conditions of high temperature and high humidity.
- When expose to drastic fluctuation of temperature(hot to cold or cold to hot), the LCD may be affected; specifically, drastic temperature fluctuation from cold to hot, produces dew on the LCD's surface which may affect the operation of the polarizer on the LCD.
- Response time will be extremely delayed at lower temperature than the operating temperature range and on the other hand LCD may turn black at temperature above its operational range. However those phenomenon do not mean malfunction or out of order with the LCD. The LCD will revert to normal operation once the temperature returns to the recommended temperature range for normal operation
- Do not display the fixed pattern for a long time because it may develop image sticking due to the LCD structure. If the screen is displayed with fixed pattern, use a screen saver. □ Do not disassemble and/or re-assemble LCD module

### **10.5 Packaging**

- Modules use LCD element, and must be treated as such.
  - Avoid intense shock and falls from a height.
  - To prevent modules from degradation, do not operate or store them exposed directly to sunshine or high temperature/humidity for long periods.





## **10.6 Storage**

- A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit. Relative humidity of the environment should therefore be kept below 60%RH
- Original protective film should be used on LCD's surface (polarizer). Adhesive type protective film should be avoided, because it may change color and/or properties of the polarizer.
- Do not store the LCD near organic solvents or corrosive gasses.
- Keep the LCD safe from vibration, shock and pressure.
- Black or white air-bubbles may be produced if the LCD is stored for long time in the lower temperature or mechanical shocks are applied onto the LCD.
- In the case of storing for a long period of time for the purpose or replacement use, the following ways are recommended.
  - Store in a polyethylene bag with sealed so as not to enter fresh air outside in it.
  - Store in a dark place where neither exposure to direct sunlight nor light is.
  - Keep temperature in the specified storage temperature range.
  - Store with no touch on polarizer surface by anything else. If possible, store the LCD in the packaging situation when it was delivered

## **10.7 Safety**

- For the crash damaged or unnecessary LCD, it is recommended to wash off liquid crystal by either of solvents such as acetone and ethanol and should be burned up later.
- In the case of LCD is broken, watch out whether liquid crystal leaks out or not. If your hands touch the liquid crystal, wash your hands cleanly with water and soap as soon as possible.
- If you should swallow the liquid crystal, first, wash your mouth thoroughly with water, then drink a lot of water and induce vomiting, and then, consult a physician.
- If the liquid crystal gets in your eyes, flush your eyes with running water for at least fifteen minutes.
- If the liquid crystal touches your skin or clothes, remove it and wash the affected part of your skin or clothes with soap and running water.

## **11.0 APPLICATION SCOPE**

- This product specification only applies to the products manufactured and sold by our company.
- Any specification, quality etc. about other parts mentioned in this product spec are no concern of our company.

